APPLICABLE STANDARI	)									
Operating	,			C+2	nrage					
Temperature	e Range	-55 °C to +105 °C ''		Ten	Storage Temperature Range			-10 °C to +60 °C <sup>(2)</sup>		
Rating Voltage		100 V AC				Range		Relative humidity		MAX
Current		υэΔ			erating midity Range			(Not dewed)		
		SPEC	IFICA	TIONS						
ITEM		TEST METHOD					REQU	IREMENTS	QT	ΑT
CONSTRUCTION				•					•	
		y and by measuring instrument.			According to drawing.			ing.	×	×
Marking		ed visually.							×	×
ELECTRIC CHARACTERIS							. (0)			
Contact Resistance		(DC or 1000 Hz)			30 mΩ MAX <sup>(3)</sup>				×	_
Insulation Resistance	250 V	AC for 1 min.			1000 MΩ MIN  No flashover or breakdown.				×	$\vdash$
Voltage Proof MECHANICAL CHARACTE		NO TOT I IIIIII.			NO 118	asnover	ומ זט	teakuowii. /1	V х	
MECHANICAL CHARACTE		d by applicable connector		1	Īnac	tion F	oroc.	SU U N WAY	×	Ι_
Insertion and Withdrawal Forces	weasure	u by applicable connector.			Insertion Force: 80.0 N MAX Withdrawal Force: 8.0 N MIN				×	1 -
		times insertions and extractions.			1) Contact Resistance : 40 m $\Omega$ MAX (3)				×	<del>  -</del>
•						2) No damage, crack and looseness of				
Vibratian	10 1 55 1 10 11				parts.				1	<u> </u>
Vibration		ency 10 to 55 to 10 Hz, approx 5 min.			1) No electrical discontinuity of 1 $\mu$ 2) No damage, crack and looseness of				×	-
Shock	400 m/	for 3 axial directions.  490 m/s <sup>2</sup> , duration of pulse 11 ms				parts.				
		) m/s, duration of pulse 11 ms 3 times for 3 both axial directions.							×	
ENVIRONMENTAL CHARA			. 50 ( 0110 .							1
Damp Heat		at $40 \pm 2$ °C, 90 to 95 9	%, 96 h	]	1) Con	tact Re	sistar	nce : 40 m $\Omega$ MAX $^{(3)}$	×	Τ-
(Steady state)					2)Insulation Resistance: 1000 M $\Omega$ MIN 3)No damage, crack and looseness of					
Rapid Change of		rature: -55 → +85 °C							×	-
Temperature		: 30 → 30 min.			par	ts.				
	Under 5	cycles. ion time to chamber: within	n 2 +c 2	MIN/						
Dry Heat			11 Z LU 3	W111N/	1) Cont	act Re	sistar	nce : 40 mo MAY (3)	×	<u> </u>
טו אַ וופּמנ	Lyhogen	xposed at +105 °C, 96 h			1) Contact Resistance : 40 m $\Omega$ MAX (3) 2) No damage, crack and looseness of				×	1 -
Cold	Exposed	at -55 °C, 96 h			parts.				×	-
Resistance to	1) Reflow	)Reflow soldering:			No deformation of case of excessive				×	+-
Soldering Heat	Peak TMP: 260 °C MAX				looseness of the terminal.					1
		Reflow TMP: 220 °C MIN for 60 sec								
		ring irons: 360 °C MAX for	r 5 sec						×	
Solderability		Soldered at solder temperature				A new uniform coating of solder shall cover a minimum of 95 % of the surface				-
240		$0 \pm 3$ °C for immersion duration, 3 sec			cover a minimum o being immersed.			1 90 % of the surface		
Λ	DESCRIPTI	ON OF REVISIONS		DESIG				CHECKED	DA	TE
<u>/1\</u> 2				MT. ITANO				HT. YAMAGUCHI	18.0	
REMARKS	KEMAKKS 1) Include temperature rise caused by current-carrying.				APPROVED			NH. NAKATA	17. 1	
(2)"Storage" means a long-term st	(2)"Storage" means a long-term storage state for the unpacked part before assembly to pcb.				CHECKED			MK. NAGATA	17. 1	
(3) Contact resistance of relay board is not included. It becomes contact resistance				1 connector. 1		DESIG		KJ. NISHIWAKI	17.1	
Unless otherwise specified, refer to IEC 60512.					DRAWN		WN	KJ. NISHIWAKI		
Note QT:Qualification Test AT:Assurance Test X:Applicable Test					DRAWING NO.			ELC-367040-00-00		
SPECIFICATION SHEET HIROSE ELECTRIC CO. LTD.				PART	PART NO.		FX27-120S-0. 8SV			
HIROSE ELECTRIC CO., LTD. CO					NO.	С	L57	7-1001-0-00	$\triangle$	1/1